	OPERATING	RD	-35	°C TO +85°C(N	NOTE 1)		RAGE		-10°C TO +60°C	(NOTE 3)	
TEMPERATURE OPERATING HUMIDITY RANG			20% TO 80%(NOTE 2) 100V AC / DC AWG#34,36: 0.3(MAX0.8A) AWG#40: 0.25A AWG#42: 0.2A AWG#44: 0.15A AWG#46: 0.1A			TEMPERATU STORAGE			40% TO 70%(NOT	,	
RATING	VOLTAGE CURRENT					APPL	APPLICABLE CONNECTOR		DF81※-30S-0).4H(##)	
\triangle						APPLICABLE CABLE 4)			THIN COAXIAL CABLE : AWG#36~AWG#46 / DISCRETE CABLE : AWG#34~40(Jacket : φ0.		6 <u>=</u>
				SPE	CIFICAT	ΓΙΟΝ	IS				
	EM			TEST METHOD				RE	QUIREMENTS	QT	
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GENERAL EX	AMINATION			MEASURING INS	STRUMENT.		ACCOR	DING TO DF	RAWING.	X	4
MARKING			MED VISUA	LLY.						Х	
	CHARACT			0.1.1>			001174	OT 00 0 14	A.V		_
CONTACT RE	SISTANCE	100m A	(DC OR 100	U HZ).				CT:80mΩ M/		X	
INSULATION RESISTANCE		100V DC.					SHIELDING:80mΩ MAX. 50MΩ MIN.			X	+
		250V AC FOR 1 min.					NO EL A	01101/50 05	2 222 41/2 014/41		4
VOLTAGE PR							NO FLA	OHUVEK OF	R BREAKDOWN.	Х	\perp
	CAL CHARA						_				
MECHANICAL OPERATION		30 TIMES INSERTIONS AND EXTRACTIONS.					 ① CONTACT RESISTANCE: NO VARIATION OF 50 mΩ OR MORE FROM INITIAL VALUE. SHIELDING RESISTANCE: NO VARIATION OF 50 mΩ OR MORE FROM INITIAL VALUE. ② NO DAMAGE, CRACK OR LOOSENESS OF 			М	
VIBRATION		FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE					PARTS. ① NO ELECTRICAL DISCONTINUITY OF 1 μs.				+
VIBRATION		0.75 mm, 3 DIRECTIONS × 10 CYCLE.					② NO DAMAGE, CRACK OR LOOSENESS OF				
SHOCK		490 m/s ² DURATION OF PULSE 11 ms AT 3 TIMES FOR				FOD 3	PARTS.				\neg
		I DIRECTI	IONS	01 1 0202 1111	ns AT3 TIMES	FOR 3	PAR	15.		X	
FNVIRONI	MENTAL CH	DIRECTI			ns AT3 TIMES	FOR 3	PAR	15.		^	
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RAPID CHANG TEMPERATUF DAMP HEAT	GE OF RE	TEMPER TIME UNDER	ERISTIC RATURE -5 30 5 CYCLES. (ER IS 2-3 MI	S 5 →+85 °C → 30 min (THE TRANSFER	RRING TIME OI		① CON NO \ INIT SHIE NO \	TACT RESIS VARIATION IAL VALUE. ILDING RES	OF 50 m Ω OR MORE FRC	M X	
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RAPID CHANG TEMPERATUR DAMP HEAT (STEADY STA	GE OF RE TE)	HARACT TEMPER TIME UNDER CHAMBE EXPOSE	ERISTIC RATURE -5 30 5 CYCLES. (ER IS 2-3 MI ED AT 40 ±	S 5 →+85 °C → 30 min (THE TRANSFER NUTE.)	RRING TIME OI %, 96 h.	F THE	① CON NO N INIT SHIE NO N INIT ② INSU ③ NO E PAR	TACT RESISTANTION VARIATION IAL VALUE. LIDING RESISTANTION VALUE. LATION RESIDAMAGE, CF TS. ECT SUCH	OF 50 m Ω OR MORE FRO ISTANCE: OF 50 m Ω OR MORE FRO ISTANCE: 25 M Ω MIN. RACK OR LOOSENESS OI AS CORROSION WHICH	M X	
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